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Bib Data Sheet

CONFIRMATION NO. 2459

SERIAL NUMBER 10784,740	FILING DATE 02/24/2004 RULE	CLASS 438	GROUP ART UNIT 2818	ATTORNEY DOCKET NO. 001480A
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APPLICANTS

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** CONTINUING DATA *****
 This application is a DIV of 09/705,897 11/06/2000 PAT 6,717,262 *dz*

** FOREIGN APPLICATIONS *****
 JAPAN 2000-029927 (PAT. 02/08/2000) *dz*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
 ** 05/15/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>[Signature]</i> Examiner's Signature Initials	STATE OR COUNTRY JAPAN	SHEETS DRAWING 9	TOTAL CLAIMS 10	INDEPENDENT CLAIMS 1
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TITLE
 Mounted circuit substrate and method for fabricating the same for surface layer pads that can withstand pad erosion by molten solder applied over a plurality of times

FILING FEE	FEES: Authority has been given in Paper	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of
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